

Re-work Risk Analysis

Product: Microstim DBS III				
Can the product be impaired by re-work			Y	
	Mechanical		Y	N
Damage to plastic enclosure whilst dismantling		Metal Fatigue	Y	N
		Visible damage to product	Y	
		Bends	Y	N
		Dents	Y	N
		Scratches	Y	
	Electrical		Y	
Repair to PCB & component replacement		Visible joints		N
		Dry joints	Y	
		Added components		N
		Piggy back components		N
	Heat			N
		Visible scorch marks		N
Components on PCB		Damage to heat sensitive components	Y	
		Insulation shrinkage		
Will re-work shorten product life				N
Will re-work reduce specification				N
Will re-work reduce any safety factors				N
Compiled by				